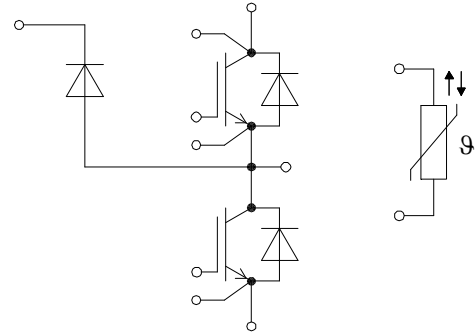
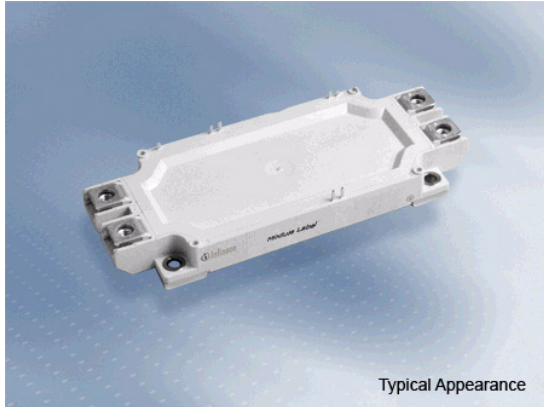


EconoDUAL™3 Modul mit Trench/Feldstopp IGBT4 und Emitter Controlled Diode und NTC  
EconoDUAL™3 module with trench/fieldstop IGBT4 and Emitter Controlled Diode and NTC



**V<sub>CEs</sub> = 650V**  
**I<sub>C nom</sub> = 400A / I<sub>CRM</sub> = 800A**

**Typische Anwendungen**

- 3-Level-Applikationen

**Typical Applications**

- 3-Level-Applications

**Elektrische Eigenschaften**

- Erweiterte Sperrschichttemperatur T<sub>vj op</sub>
- Niedrige Schaltverluste
- Niedriges V<sub>CEsat</sub>
- Sehr große Robustheit
- T<sub>vj op</sub> = 150°C
- V<sub>CEsat</sub> mit positivem Temperaturkoeffizienten

**Electrical Features**

- Extended Operation Temperature T<sub>vj op</sub>
- Low Switching Losses
- Low V<sub>CEsat</sub>
- Unbeatable Robustness
- T<sub>vj op</sub> = 150°C
- V<sub>CEsat</sub> with positive Temperature Coefficient

**Mechanische Eigenschaften**

- Isolierte Bodenplatte
- Standardgehäuse

**Mechanical Features**

- Isolated Base Plate
- Standard Housing

**Module Label Code**

Barcode Code 128



DMX - Code



**Content of the Code**

|                            | Digit   |
|----------------------------|---------|
| Module Serial Number       | 1 - 5   |
| Module Material Number     | 6 - 11  |
| Production Order Number    | 12 - 19 |
| Datecode (Production Year) | 20 - 21 |
| Datecode (Production Week) | 22 - 23 |

|                 |                                 |                      |
|-----------------|---------------------------------|----------------------|
| prepared by: MK | date of publication: 2012-01-09 | material no: 35923   |
| approved by: MK | revision: 3.1                   | UL approved (E83335) |

**IGBT-Wechselrichter / IGBT-inverter**

**Höchstzulässige Werte / Maximum Rated Values**

|  |  |                             |            |        |
|--|--|-----------------------------|------------|--------|
| Kollektor-Emitter-Sperrspannung<br>Collector-emitter voltage             | $T_{vj} = 25^{\circ}\text{C}$  | $V_{CES}$                   | 650        | V      |
| Kollektor-Dauergleichstrom<br>Continuous DC collector current            | $T_C = 50^{\circ}\text{C}, T_{vj} = 175^{\circ}\text{C}$<br>$T_C = 25^{\circ}\text{C}, T_{vj} = 175^{\circ}\text{C}$ | $I_{C\text{ nom}}$<br>$I_C$ | 400<br>450 | A<br>A |
| Periodischer Kollektor-Spitzenstrom<br>Repetitive peak collector current | $t_p = 1\text{ ms}$  | $I_{CRM}$                   | 800        | A      |
| Gesamt-Verlustleistung<br>Total power dissipation                        | $T_C = 25^{\circ}\text{C}, T_{vj} = 175^{\circ}\text{C}$   | $P_{tot}$                   | 1150       | W      |
| Gate-Emitter-Spitzenspannung<br>Gate-emitter peak voltage                |  | $V_{GES}$                   | +/-20      | V      |

**Charakteristische Werte / Characteristic Values**

|   |   |   | min.                | typ.                    | max. |             |   |
|---|---|---|---------------------|-------------------------|------|-------------|---|
| Kollektor-Emitter-Sättigungsspannung<br>Collector-emitter saturation voltage    | $I_C = 400\text{ A}, V_{GE} = 15\text{ V}$<br>$I_C = 400\text{ A}, V_{GE} = 15\text{ V}$<br>$I_C = 400\text{ A}, V_{GE} = 15\text{ V}$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $V_{CE\text{ sat}}$ | 1,55<br>1,70<br>1,75    | 1,95 | V<br>V<br>V |   |
| Gate-Schwellenspannung<br>Gate threshold voltage                                | $I_C = 6,40\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$  |   | $V_{GEth}$          | 4,9                     | 5,8  | 6,5         | V   |
| Gateladung<br>Gate charge   | $V_{GE} = -15\text{ V} \dots +15\text{ V}$  |   | $Q_G$               | 4,30                    |      |             | $\mu\text{C}$                                   |
| Interner Gatewiderstand<br>Internal gate resistor                               | $T_{vj} = 25^{\circ}\text{C}$   |   | $R_{Gint}$          | 1,0                     |      |             | $\Omega$  |
| Eingangskapazität<br>Input capacitance  | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$  |   | $C_{ies}$           | 26,0                    |      |             | nF  |
| Rückwirkungskapazität<br>Reverse transfer capacitance                           | $f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$  |   | $C_{res}$           | 0,76                    |      |             | nF  |
| Kollektor-Emitter-Reststrom<br>Collector-emitter cut-off current                | $V_{CE} = 650\text{ V}, V_{GE} = 0\text{ V}, T_{vj} = 25^{\circ}\text{C}$   |   | $I_{CES}$           |                         |      | 1,0         | mA  |
| Gate-Emitter-Reststrom<br>Gate-emitter leakage current                          | $V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$  |   | $I_{GES}$           |                         |      | 100         | nA  |
| Einschaltverzögerungszeit, induktive Last<br>Turn-on delay time, inductive load | $I_C = 400\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$<br>$R_{Gon} = 3,6\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $t_{d\text{ on}}$   | 0,12<br>0,12<br>0,12    |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Anstiegszeit, induktive Last<br>Rise time, inductive load                       | $I_C = 400\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$<br>$R_{Gon} = 3,6\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $t_r$               | 0,14<br>0,14<br>0,14    |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Abschaltverzögerungszeit, induktive Last<br>Turn-off delay time, inductive load | $I_C = 400\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$<br>$R_{Goff} = 3,6\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $t_{d\text{ off}}$  | 0,63<br>0,66<br>0,67    |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Fallzeit, induktive Last<br>Fall time, inductive load                           | $I_C = 400\text{ A}, V_{CE} = 300\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$<br>$R_{Goff} = 3,6\ \Omega$   | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $t_f$               | 0,065<br>0,075<br>0,088 |      |             | $\mu\text{s}$<br>$\mu\text{s}$<br>$\mu\text{s}$ |
| Einschaltverlustenergie pro Puls<br>Turn-on energy loss per pulse               | $I_C = 400\text{ A}, V_{CE} = 300\text{ V}, L_S = 35\text{ nH}$<br>$V_{GE} = \pm 15\text{ V}, di/dt = 2550\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$R_{Gon} = 3,6\ \Omega$  | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $E_{on}$            | 13,5<br>17,0<br>17,5    |      |             | mJ<br>mJ<br>mJ                                  |
| Abschaltverlustenergie pro Puls<br>Turn-off energy loss per pulse               | $I_C = 400\text{ A}, V_{CE} = 300\text{ V}, L_S = 35\text{ nH}$<br>$V_{GE} = \pm 15\text{ V}, du/dt = 2000\text{ V}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$R_{Goff} = 3,6\ \Omega$ | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$                   | $E_{off}$           | 21,0<br>25,0<br>26,0    |      |             | mJ<br>mJ<br>mJ                                  |
| Kurzschlußverhalten<br>SC data  | $V_{GE} \leq 15\text{ V}, V_{CC} = 360\text{ V}$<br>$V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$   | $t_p \leq 10\ \mu\text{s}, T_{vj} = 25^{\circ}\text{C}$<br>$t_p \leq 10\ \mu\text{s}, T_{vj} = 150^{\circ}\text{C}$ | $I_{SC}$            | 1900<br>1500            |      |             | A<br>A  |
| Wärmewiderstand, Chip bis Gehäuse<br>Thermal resistance, junction to case       | pro IGBT / per IGBT   |   | $R_{thJC}$          |                         |      | 0,13        | K/W   |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink | pro IGBT / per IGBT<br>$\lambda_{Paste} = 1\text{ W}/(\text{m}\cdot\text{K}) / \lambda_{grease} = 1\text{ W}/(\text{m}\cdot\text{K})$   |   | $R_{thCH}$          |                         |      | 0,027       | K/W   |

|                 |                                 |
|-----------------|---------------------------------|
| prepared by: MK | date of publication: 2012-01-09 |
| approved by: MK | revision: 3.1                   |



**Diode-Wechselrichter / Diode-inverter**  
**Höchstzulässige Werte / Maximum Rated Values**

|   |  |           |                |  |
|---|--|-----------|----------------|--|
| Periodische Spitzensperrspannung<br>Repetitive peak reverse voltage | $T_{vj} = 25^{\circ}\text{C}$  | $V_{RRM}$ | 650            | V  |
| Dauergleichstrom<br>Continuous DC forward current                   |  | $I_F$     | 400            | A  |
| Periodischer Spitzenstrom<br>Repetitive peak forward current        | $t_p = 1 \text{ ms}$   | $I_{FRM}$ | 800            | A  |
| Grenzlastintegral<br>$I^2t$ - value                                 | $V_R = 0 \text{ V}, t_p = 10 \text{ ms}, T_{vj} = 125^{\circ}\text{C}$<br>$V_R = 0 \text{ V}, t_p = 10 \text{ ms}, T_{vj} = 150^{\circ}\text{C}$ | $I^2t$    | 11000<br>10000 | $\text{A}^2\text{s}$<br>$\text{A}^2\text{s}$ |

**Charakteristische Werte / Characteristic Values**

|   |   |   | min.       | typ.                 | max.  |   |
|---|---|---|------------|----------------------|-------|---|
| Durchlassspannung<br>Forward voltage  | $I_F = 400 \text{ A}, V_{GE} = 0 \text{ V}$<br>$I_F = 400 \text{ A}, V_{GE} = 0 \text{ V}$<br>$I_F = 400 \text{ A}, V_{GE} = 0 \text{ V}$               | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_F$      | 1,55<br>1,50<br>1,45 | 1,95  | V<br>V<br>V                                     |
| Rückstromspitze<br>Peak reverse recovery current                                | $I_F = 400 \text{ A}, -di_F/dt = 2550 \text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300 \text{ V}$<br>$V_{GE} = -15 \text{ V}$          | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $I_{RM}$   | 115<br>165<br>185    |       | A<br>A<br>A                                     |
| Sperrverzögerungsladung<br>Recovered charge                                     | $I_F = 400 \text{ A}, -di_F/dt = 2550 \text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300 \text{ V}$<br>$V_{GE} = -15 \text{ V}$          | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $Q_r$      | 23,0<br>34,0<br>42,0 |       | $\mu\text{C}$<br>$\mu\text{C}$<br>$\mu\text{C}$ |
| Abschaltenergie pro Puls<br>Reverse recovery energy                             | $I_F = 400 \text{ A}, -di_F/dt = 2550 \text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300 \text{ V}$<br>$V_{GE} = -15 \text{ V}$          | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{rec}$  | 3,80<br>6,30<br>8,00 |       | mJ<br>mJ<br>mJ                                  |
| Wärmewiderstand, Chip bis Gehäuse<br>Thermal resistance, junction to case       | pro Diode / per diode   |   | $R_{thJC}$ |                      | 0,25  | K/W   |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink | pro Diode / per diode<br>$\lambda_{\text{Paste}} = 1 \text{ W}/(\text{m}\cdot\text{K}) / \lambda_{\text{grease}} = 1 \text{ W}/(\text{m}\cdot\text{K})$ |   | $R_{thCH}$ |                      | 0,053 | K/W   |

**Diode-3-Level / Diode-3-level**

**Höchstzulässige Werte / Maximum Rated Values**

|   |  |           |                |  |
|---|--|-----------|----------------|--|
| Periodische Spitzensperrspannung<br>Repetitive peak reverse voltage | $T_{vj} = 25^{\circ}\text{C}$  | $V_{RRM}$ | 650            | V  |
| Dauergleichstrom<br>Continuous DC forward current                   |  | $I_F$     | 400            | A  |
| Periodischer Spitzenstrom<br>Repetitive peak forward current        | $t_p = 1 \text{ ms}$   | $I_{FRM}$ | 800            | A  |
| Grenzlastintegral<br>$I^2t$ - value                                 | $V_R = 0 \text{ V}, t_p = 10 \text{ ms}, T_{vj} = 125^{\circ}\text{C}$<br>$V_R = 0 \text{ V}, t_p = 10 \text{ ms}, T_{vj} = 150^{\circ}\text{C}$ | $I^2t$    | 11000<br>10000 | $\text{A}^2\text{s}$<br>$\text{A}^2\text{s}$ |

**Charakteristische Werte / Characteristic Values**

|   |   |   | min.       | typ.                 | max.  |   |
|---|---|---|------------|----------------------|-------|---|
| Durchlassspannung<br>Forward voltage  | $I_F = 400 \text{ A}, V_{GE} = 0 \text{ V}$<br>$I_F = 400 \text{ A}, V_{GE} = 0 \text{ V}$<br>$I_F = 400 \text{ A}, V_{GE} = 0 \text{ V}$               | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $V_F$      | 1,55<br>1,50<br>1,45 | 1,95  | V<br>V<br>V                                     |
| Rückstromspitze<br>Peak reverse recovery current                                | $I_F = 400 \text{ A}, -di_F/dt = 2550 \text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300 \text{ V}$<br>$V_{GE} = -15 \text{ V}$          | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $I_{RM}$   | 115<br>165<br>185    |       | A<br>A<br>A                                     |
| Sperrverzögerungsladung<br>Recovered charge                                     | $I_F = 400 \text{ A}, -di_F/dt = 2550 \text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300 \text{ V}$<br>$V_{GE} = -15 \text{ V}$          | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $Q_r$      | 23,0<br>34,0<br>42,0 |       | $\mu\text{C}$<br>$\mu\text{C}$<br>$\mu\text{C}$ |
| Abschaltenergie pro Puls<br>Reverse recovery energy                             | $I_F = 400 \text{ A}, -di_F/dt = 2550 \text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$<br>$V_R = 300 \text{ V}$<br>$V_{GE} = -15 \text{ V}$          | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = 125^{\circ}\text{C}$<br>$T_{vj} = 150^{\circ}\text{C}$ | $E_{rec}$  | 3,80<br>6,30<br>8,00 |       | mJ<br>mJ<br>mJ                                  |
| Wärmewiderstand, Chip bis Gehäuse<br>Thermal resistance, junction to case       | pro Diode / per diode   |   | $R_{thJC}$ |                      | 0,25  | K/W   |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink | pro Diode / per diode<br>$\lambda_{\text{Paste}} = 1 \text{ W}/(\text{m}\cdot\text{K}) / \lambda_{\text{grease}} = 1 \text{ W}/(\text{m}\cdot\text{K})$ |   | $R_{thCH}$ |                      | 0,053 | K/W   |

|                 |                                 |
|-----------------|---------------------------------|
| prepared by: MK | date of publication: 2012-01-09 |
| approved by: MK | revision: 3.1                   |

**NTC-Widerstand / NTC-thermistor**

**Charakteristische Werte / Characteristic Values**

|  |  |              | min. | typ. | max. |            |
|--|--|--------------|------|------|------|------------|
| Nennwiderstand<br>Rated resistance       | $T_C = 25^\circ\text{C}$                                       | $R_{25}$     |      | 5,00 |      | k $\Omega$ |
| Abweichung von R100<br>Deviation of R100 | $T_C = 100^\circ\text{C}, R_{100} = 493 \Omega$                | $\Delta R/R$ | -5   |      | 5    | %          |
| Verlustleistung<br>Power dissipation     | $T_C = 25^\circ\text{C}$                                       | $P_{25}$     |      |      | 20,0 | mW         |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$  | $B_{25/50}$  |      | 3375 |      | K          |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$  | $B_{25/80}$  |      | 3411 |      | K          |
| B-Wert<br>B-value                        | $R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$ | $B_{25/100}$ |      | 3433 |      | K          |

Angaben gemäß gültiger Application Note.  
Specification according to the valid application note.

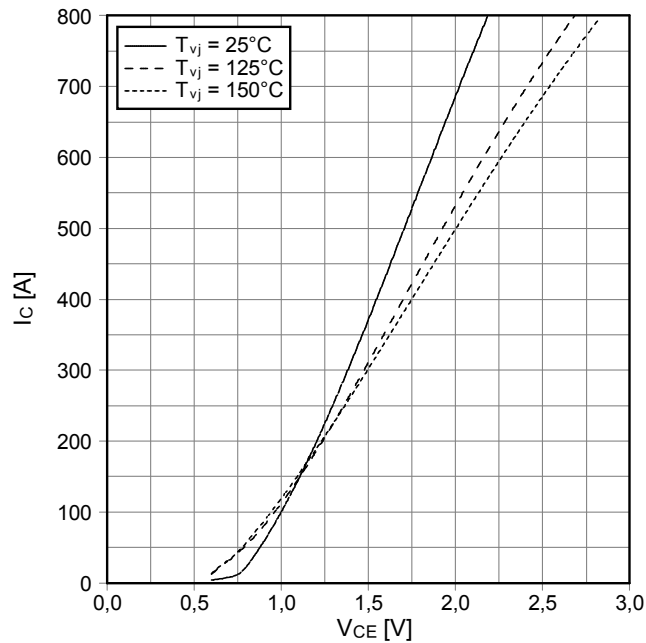
**Modul / Module**

|  |  |                             |      |                                |      |                  |
|--|--|-----------------------------|------|--------------------------------|------|------------------|
| Isolations-Prüfspannung<br>Isolation test voltage                                      | RMS, f = 50 Hz, t = 1 min  | $V_{\text{ISOL}}$           |      | 2,5                            |      | kV               |
| Material Modulgrundplatte<br>Material of module baseplate                              |  |                             |      | Cu                             |      |                  |
| Innere Isolation<br>Internal isolation   |  |                             |      | Al <sub>2</sub> O <sub>3</sub> |      |                  |
| Kriechstrecke<br>Creepage distance   | Kontakt - Kühlkörper / terminal to heatsink<br>Kontakt - Kontakt / terminal to terminal  |                             |      | 14,5<br>13,0                   |      | mm               |
| Luftstrecke<br>Clearance   | Kontakt - Kühlkörper / terminal to heatsink<br>Kontakt - Kontakt / terminal to terminal  |                             |      | 12,5<br>10,0                   |      | mm               |
| Vergleichszahl der Kriechwegbildung<br>Comperative tracking index                      |  | CTI                         |      | > 200                          |      |                  |
|  |  |                             | min. | typ.                           | max. |                  |
| Wärmewiderstand, Gehäuse bis Kühlkörper<br>Thermal resistance, case to heatsink        | pro Modul / per module<br>$\lambda_{\text{Paste}} = 1 \text{ W}/(\text{m}\cdot\text{K}) / \lambda_{\text{grease}} = 1 \text{ W}/(\text{m}\cdot\text{K})$ | $R_{\text{thCH}}$           |      | 0,009                          |      | K/W              |
| Modulstreuintduktivität<br>Stray inductance module                                     |  | $L_{\text{sCE}}$            |      | 35                             |      | nH               |
| Modulleitungswiderstand, Anschlüsse - Chip<br>Module lead resistance, terminals - chip | $T_C = 25^\circ\text{C}$ , pro Schalter / per switch   | $R_{\text{CC}'+\text{EE}'}$ |      | 1,45                           |      | m $\Omega$       |
| Höchstzulässige Sperrschichttemperatur<br>Maximum junction temperature                 | Wechselrichter, Brems-Chopper / Inverter, Brake-Chopper  | $T_{\text{vj max}}$         |      |                                | 175  | $^\circ\text{C}$ |
| Temperatur im Schaltbetrieb<br>Temperature under switching conditions                  | Wechselrichter, Brems-Chopper / Inverter, Brake-Chopper  | $T_{\text{vj op}}$          | -40  |                                | 150  | $^\circ\text{C}$ |
| Lagertemperatur<br>Storage temperature   |  | $T_{\text{stg}}$            | -40  |                                | 125  | $^\circ\text{C}$ |
| Anzugsdrehmoment f. Modulmontage<br>Mounting torque for modul mounting                 | Schraube M5 - Montage gem. gültiger Applikation Note<br>screw M5 - mounting according to valid application note  | M                           | 3,00 | -                              | 6,00 | Nm               |
| Anzugsdrehmoment f. elektr. Anschlüsse<br>Terminal connection torque                   | Schraube M6 - Montage gem. gültiger Applikation Note<br>screw M6 - mounting according to valid application note  | M                           | 3,0  | -                              | 6,0  | Nm               |
| Gewicht<br>Weight  |  | G                           |      | 345                            |      | g                |

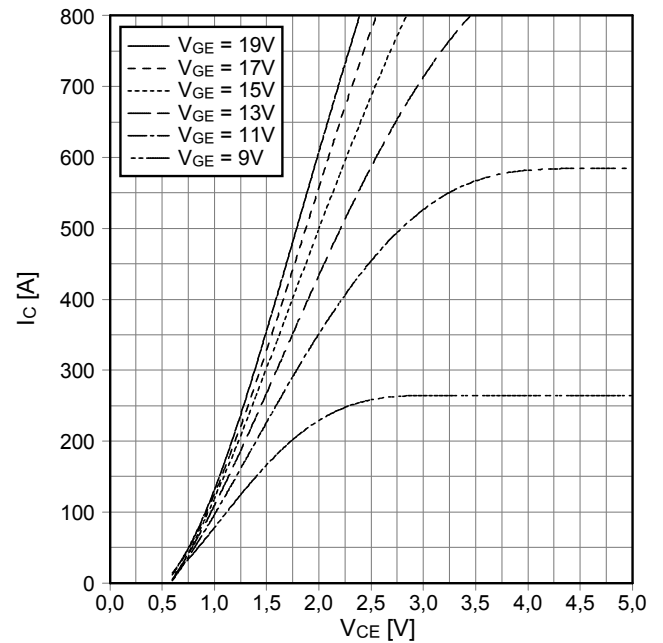
|                 |                                 |
|-----------------|---------------------------------|
| prepared by: MK | date of publication: 2012-01-09 |
| approved by: MK | revision: 3.1                   |



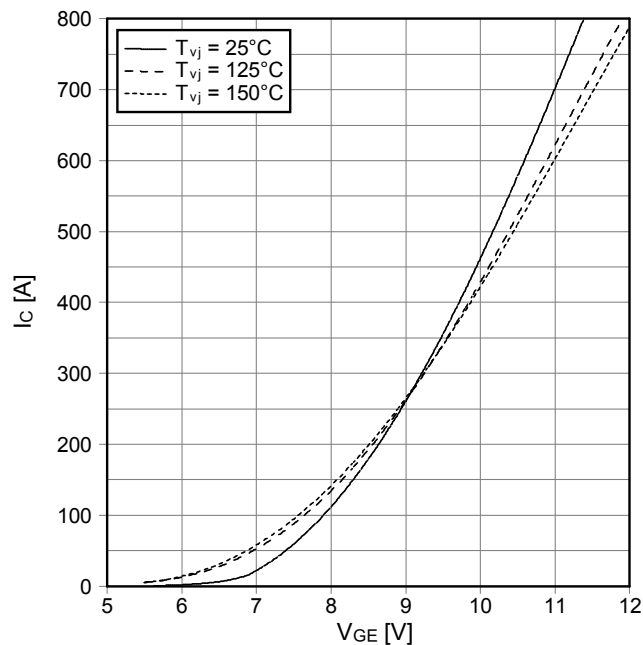
**Ausgangskennlinie IGBT-Wechselr. (typisch)**  
output characteristic IGBT-inverter (typical)  
 $I_c = f(V_{CE})$   
 $V_{GE} = 15\text{ V}$



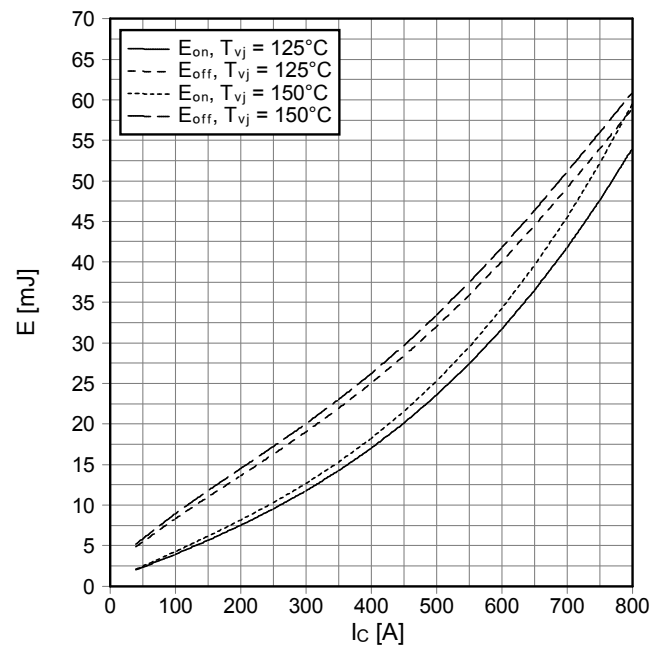
**Ausgangskennlinienfeld IGBT-Wechselr. (typisch)**  
output characteristic IGBT-inverter (typical)  
 $I_c = f(V_{CE})$   
 $T_{vj} = 150^\circ\text{C}$



**Übertragungscharakteristik IGBT-Wechselr. (typisch)**  
transfer characteristic IGBT-inverter (typical)  
 $I_c = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



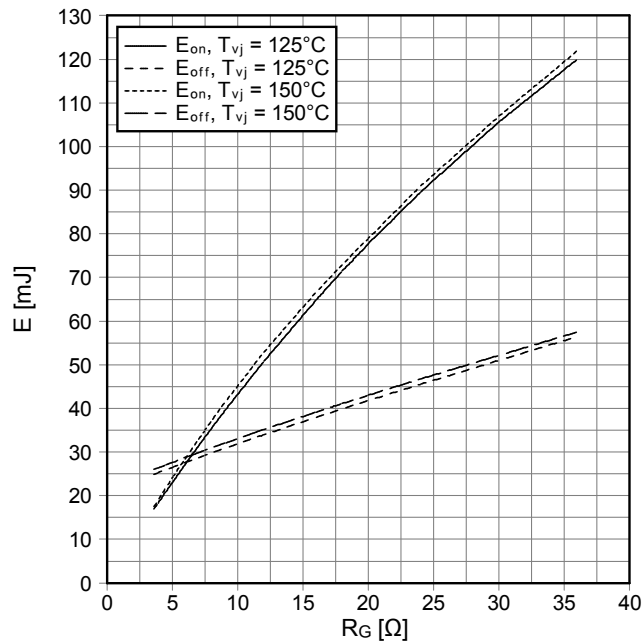
**Schaltverluste IGBT-Wechselr. (typisch)**  
switching losses IGBT-inverter (typical)  
 $E_{on} = f(I_c), E_{off} = f(I_c)$   
 $V_{GE} = \pm 15\text{ V}, R_{Gon} = 3.6\ \Omega, R_{Goff} = 3.6\ \Omega, V_{CE} = 300\text{ V}$



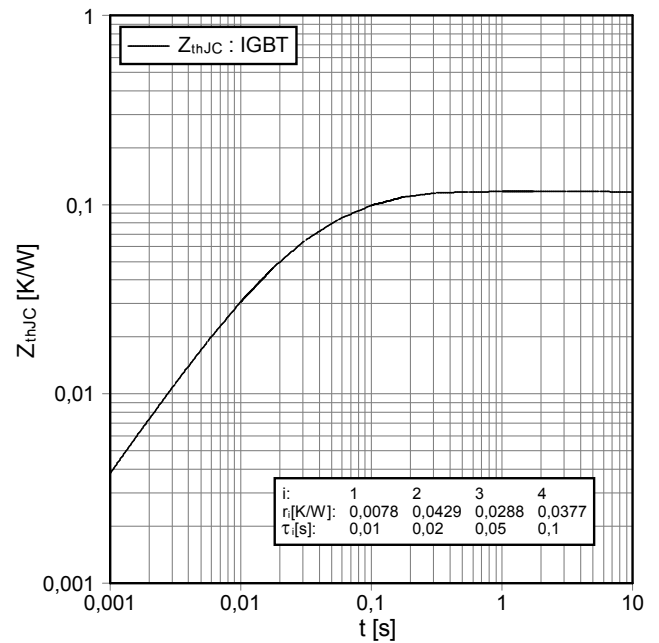
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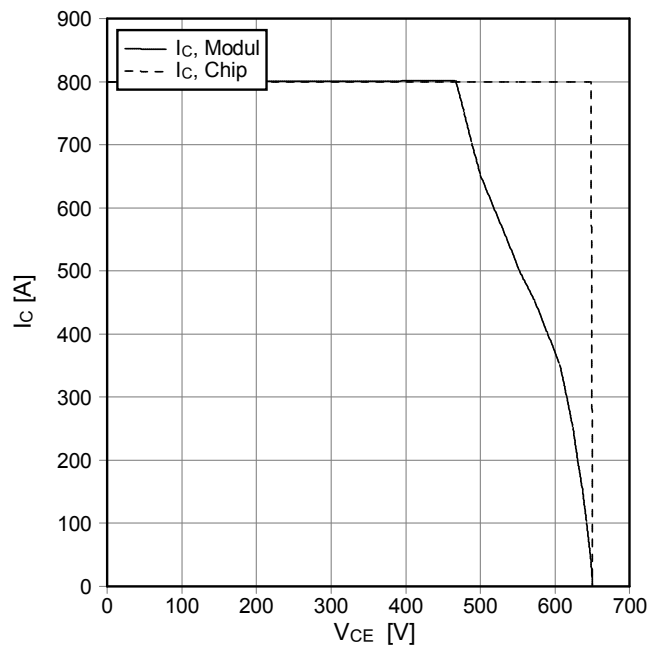
**Schaltverluste IGBT-Wechselr. (typisch)**  
switching losses IGBT-Inverter (typical)  
 $E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$   
 $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 400\text{ A}$ ,  $V_{CE} = 300\text{ V}$



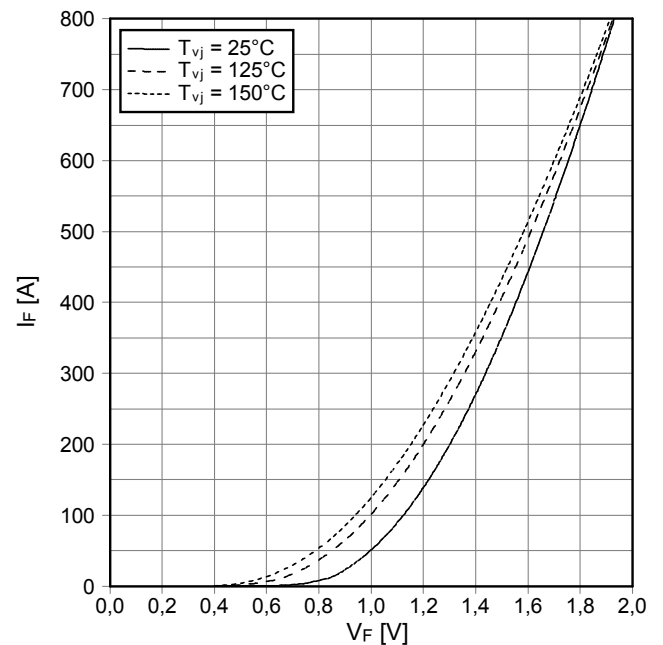
**Transienter Wärmewiderstand IGBT-Wechselr.**  
transient thermal impedance IGBT-inverter  
 $Z_{thJC} = f(t)$



**Sicherer Rückwärts-Arbeitsbereich IGBT-Wr. (RBSOA)**  
reverse bias safe operating area IGBT-inv. (RBSOA)  
 $I_C = f(V_{CE})$   
 $V_{GE} = \pm 15\text{ V}$ ,  $R_{Goff} = 3.6\ \Omega$ ,  $T_{vj} = 150^\circ\text{C}$



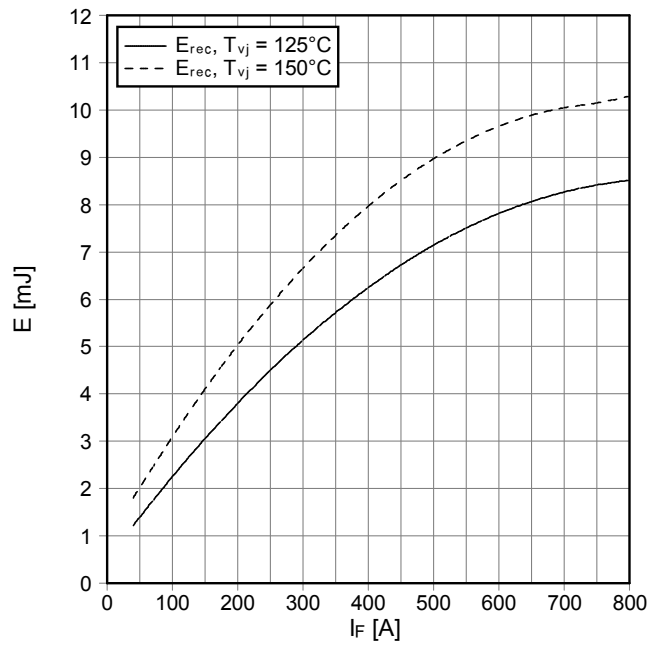
**Durchlasskennlinie der Diode-Wechselr. (typisch)**  
forward characteristic of diode-inverter (typical)  
 $I_F = f(V_F)$



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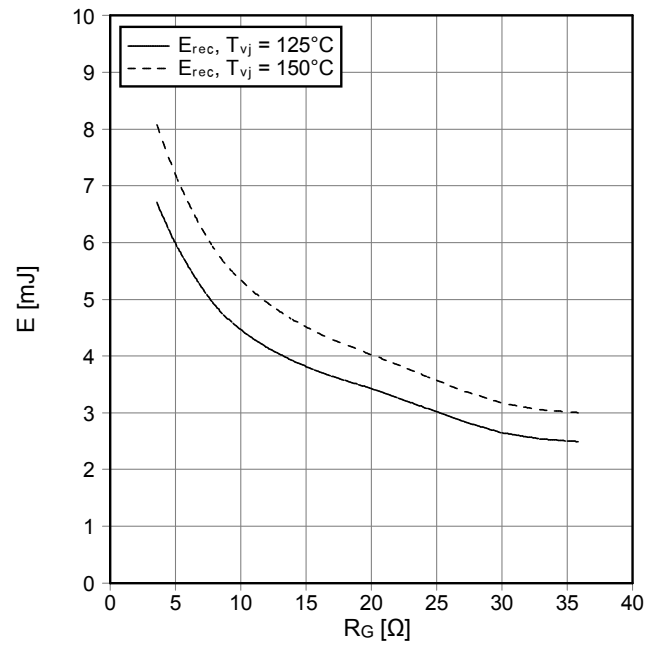
**Schaltverluste Diode-Wechselr. (typisch)**  
**switching losses diode-inverter (typical)**

$E_{rec} = f(I_F)$   
 $R_{Gon} = 3.6 \Omega, V_{CE} = 300 V$



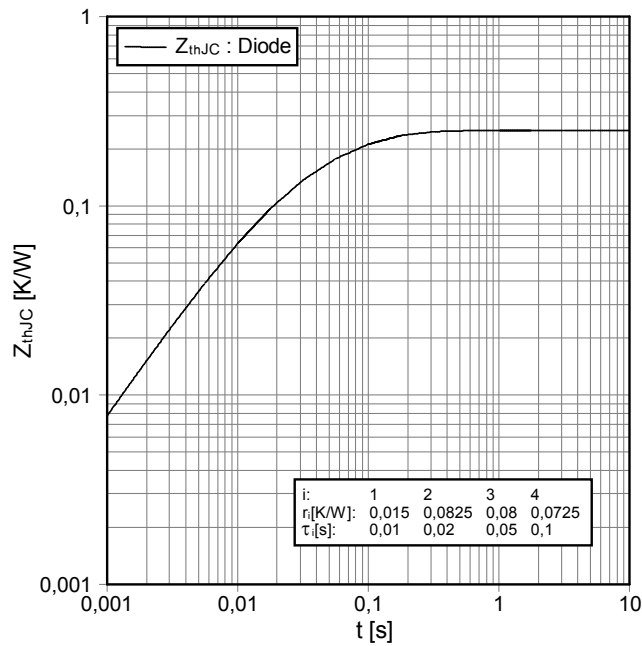
**Schaltverluste Diode-Wechselr. (typisch)**  
**switching losses diode-inverter (typical)**

$E_{rec} = f(R_G)$   
 $I_F = 400 A, V_{CE} = 300 V$



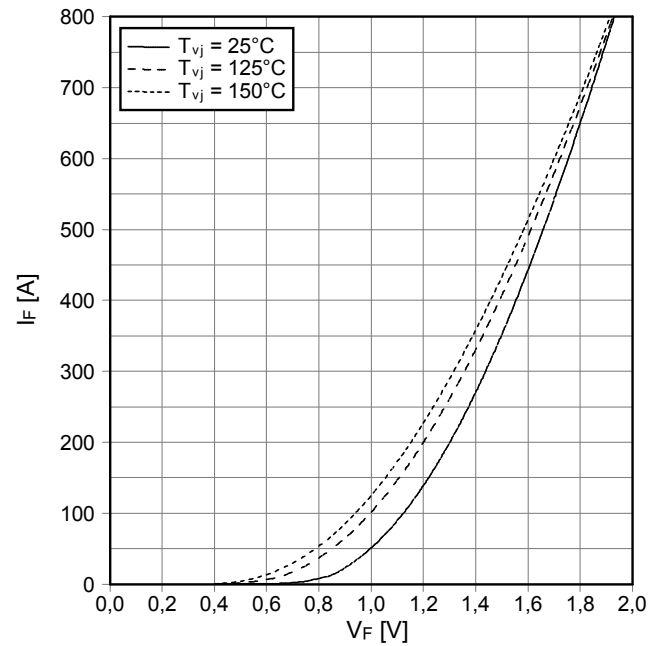
**Transienter Wärmewiderstand Diode-Wechselr.**  
**transient thermal impedance diode-inverter**

$Z_{thJC} = f(t)$



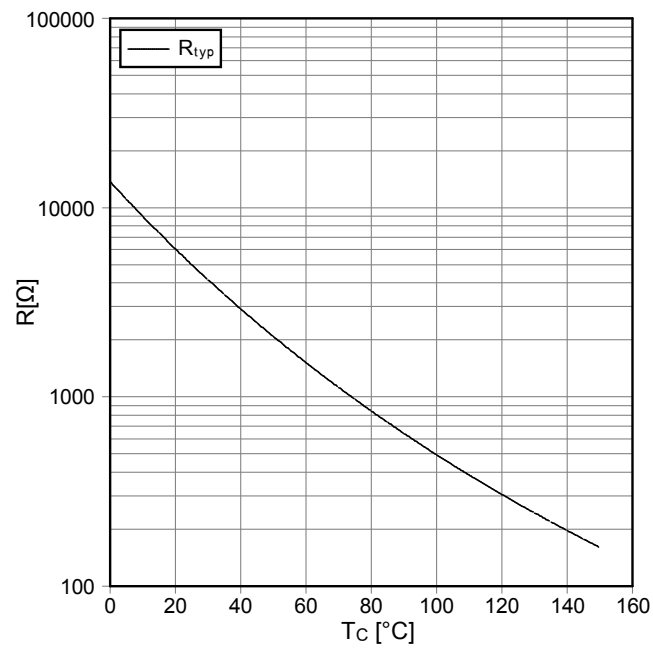
**Durchlasskennlinie der Diode-3-Level**  
**forward characteristic of Diode-3-level**

$I_F = f(V_F)$



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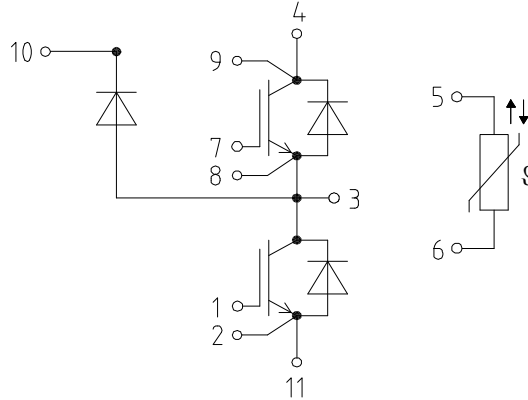
NTC-Temperaturkennlinie (typisch)  
NTC-temperature characteristic (typical)  
 $R = f(T)$



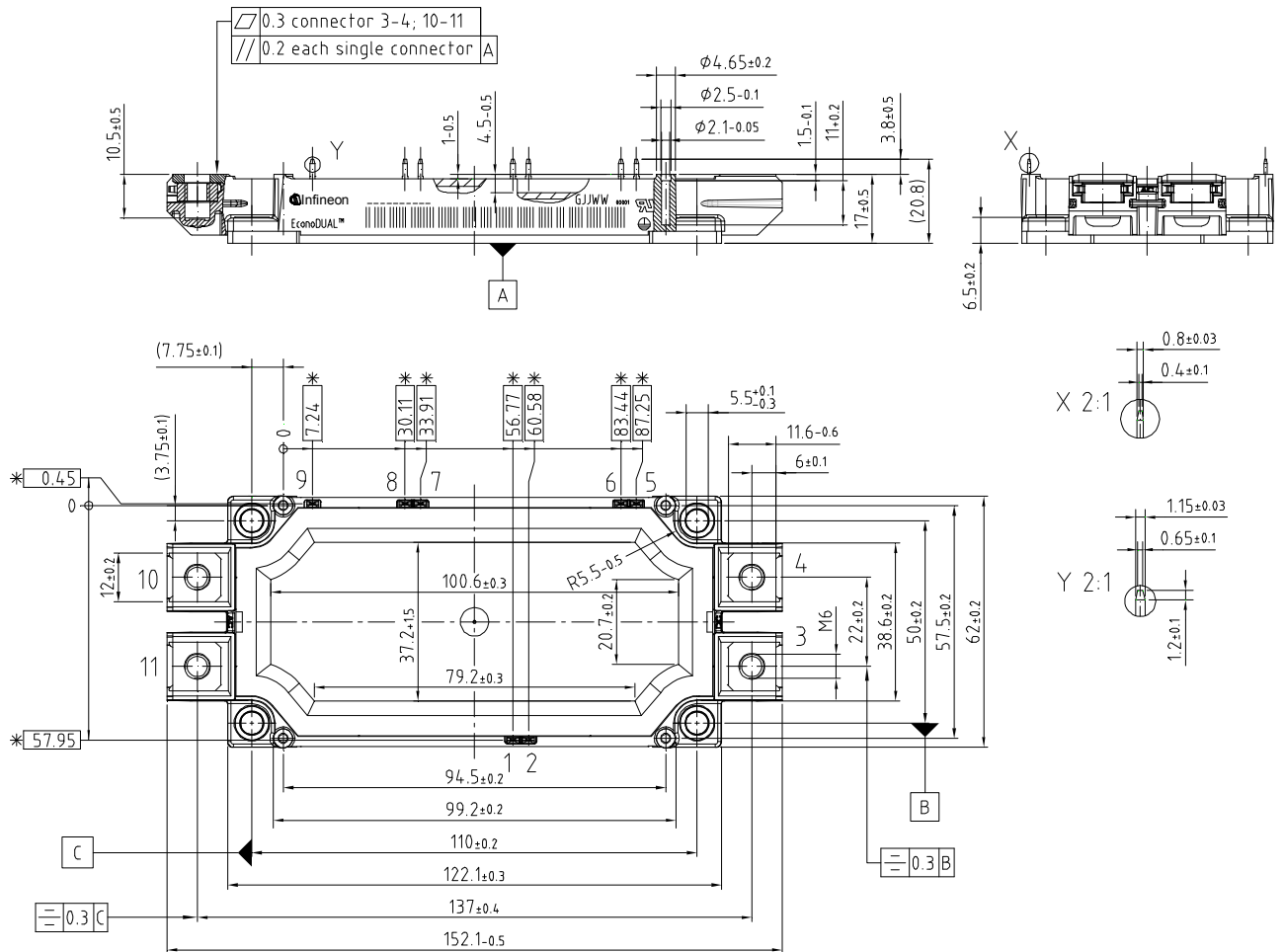
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Schaltplan / circuit diagram



Gehäuseabmessungen / package outlines



\* = all dimensions with a tolerance of  $\pm 0.5$

dimensions valid in mounted condition

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